

# STGF19NC60SD STGP19NC60SD

## 20 A, 600 V fast IGBT with Ultrafast diode

### Features

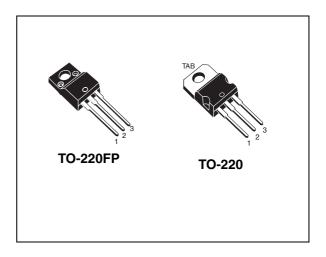
- Very low on-voltage drop (V<sub>CE(sat)</sub>)
- Minimum power losses at 5 kHz in hard switching
- Optimized performance for medium operating frequencies.
- IGBT co-packaged with Ultrafast freewheeling diode

### Application

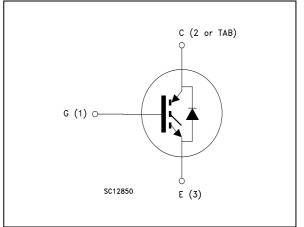
Medium frequency motor drives

### Description

This IGBT utilizes the advanced PowerMESH<sup>™</sup> process resulting in an excellent trade-off between switching performance and low on-state behavior.



### Figure 1. Internal schematic diagram



#### Table 1.Device summary

Order codes	Marking	Package	Packaging
STGF19NC60SD	GF19NC60SD	TO-220FP	Tube
STGP19NC60SD	GP19NC60SD	TO-220	Tube

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## 1 Electrical ratings

Cumhal	Devenueter	Va	11	
Symbol	Parameter	TO-220	TO-220FP	Unit
V <sub>CES</sub>	Collector-emitter voltage ( $V_{GE} = 0$ )	60	00	V
I <sub>C</sub> <sup>(1)</sup>	Continuous collector current at $T_C = 25^{\circ}C$	40	17	А
$I_{C}^{(1)}$	Continuous collector current at $T_C = 100^{\circ}C$	20	11	А
$I_{CP}^{(2)}$	Pulsed collector current	80		А
I <sub>CL</sub> <sup>(3)</sup>	Turn-off latching current	80		А
١ <sub>F</sub>	Diode RMS forward current at Tc = 25°C	20		А
I <sub>FSM</sub>	Surge non repetitive forward current $t_p = 10ms$ sinusoidal	50		A
$V_{GE}$	Gate-emitter voltage	±ź	20	V
V <sub>ISO</sub>	Insulation withstand voltage (RMS) from all three leads to external heat sink (t = 1 s; Tc = 25 °C)	2500		v
P <sub>TOT</sub>	Total dissipation at $T_{C} = 25^{\circ}C$	130 32		W
Τj	Operating junction temperature	- 55 t	o 150	°C

Table 2.	Absolute	maximum	ratings
	/	maximam	radingo

1. Calculated according to the iterative formula

$$I_{C}(T_{C}) = \frac{T_{j(max)} - T_{C}}{R_{thj-c} \times V_{CE(sat)(max)}(T_{j(max)}, I_{C}(T_{C}))}$$

2. Pulse width limited by maximum junction temperature and turn-off within RBSOA

3. Vclamp = 80% of V<sub>CES</sub>,  $T_j$  =150 °C,  $R_G$ =10  $\Omega$ ,  $V_{GE}$ =15 V

Symbol		Parameter	Va	Unit	
		Falameter	TO-220	TO-220FP	Onit
Thermal resistance		Thermal resistance junction-case IGBT	0.96	3.9	°C/W
R <sub>thj-c</sub> Thermal resistance junction-ca		Thermal resistance junction-case diode	3	5.5	°C/W
R	thj -a	Thermal resistance junction-ambient	62.5		°C/W

#### Table 3. Thermal data



## 2 Electrical characteristics

 $(T_i = 25^{\circ}C \text{ unless otherwise specified})$ 

Table 4.	Static
	•••••••

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)CES</sub>	Collector-emitter breakdown voltage (V <sub>GE</sub> = 0)	I <sub>C</sub> = 1mA	600			V
V <sub>CE(sat)</sub>	Collector-emitter saturation voltage	V <sub>GE</sub> = 15V, I <sub>C</sub> = 12A V <sub>GE</sub> = 15V, I <sub>C</sub> =12A,T <sub>j</sub> =125°C		1.55 1.35	1.9	V V
V <sub>GE(th)</sub>	Gate threshold voltage	$V_{CE} = V_{GE}$ , $I_C = 250 \ \mu A$	4.2		6.2	V
I <sub>CES</sub>	Collector cut-off current (V <sub>GE</sub> = 0)	V <sub>CE</sub> = 600 V V <sub>CE</sub> = 600 V, T <sub>j</sub> =125°C			150 1	μA mA
I <sub>GES</sub>	Gate-emitter leakage current (V <sub>CE</sub> = 0)	$V_{GE}$ = ±20V, $V_{CE}$ = 0			±100	nA
9 <sub>fs</sub>	Forward transconductance	$V_{CE} = 15V_{,}I_{C} = 12A$		10		S

### Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C <sub>ies</sub> C <sub>oes</sub> C <sub>res</sub>	Input capacitance Output capacitance Reverse transfer capacitance	V <sub>CE</sub> = 25V, f = 1MHz, V <sub>GE</sub> = 0	-	1190 135 28.5	-	pF pF pF
Q <sub>g</sub> Q <sub>ge</sub> Q <sub>gc</sub>	Total gate charge Gate-emitter charge Gate-collector charge	$V_{CE}$ = 480V, I <sub>C</sub> = 12A, $V_{GE}$ = 15V, <i>Figure 20</i>	-	54.5 8.7 25.8	-	nC nC nC



Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub> t <sub>r</sub> (di/dt)on	Turn-on delay time Current rise time Turn-on current slope	$V_{CC} = 480$ V, $I_{C} = 12$ A $R_{G} = 10$ Ω, $V_{GE} = 15$ V, <i>Figure 21</i>	-	17.5 6.2 1870	-	ns ns A/µs
t <sub>d(on)</sub> t <sub>r</sub> (di/dt)on	Turn-on delay time Current rise time Turn-on current slope	$V_{CC} = 480V, I_C = 12A$ $R_G = 10\Omega, V_{GE} = 15V,$ $T_j = 125^{\circ}C$ <i>Figure 21</i>	-	17 6.5 1700	-	ns ns A/µs
t <sub>r(Voff)</sub> t <sub>d(Voff)</sub> t <sub>f</sub>	Off voltage rise time Turn-off delay time Current fall time	$V_{CC} = 480V, I_C = 12A$ $R_G = 10\Omega V_{GE} = 15V,$ <i>Figure 21</i>	-	90 175 215	-	ns ns ns
t <sub>r(Voff)</sub> t <sub>d(Voff)</sub> t <sub>f</sub>	Off voltage rise time Turn-off delay time Current fall time	$V_{CC} = 480V, I_C = 12A$ $R_G = 10\Omega, V_{GE} = 15V,$ $T_j = 125^{\circ}C$ <i>Figure 21</i>	-	155 245 290	-	ns ns ns

Table 6. Switching on/off (inductive load)

 Table 7.
 Switching energy (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
E <sub>on</sub> E <sub>off</sub> <sup>(1)</sup> E <sub>ts</sub>	Turn-on switching losses Turn-off switching losses Total switching losses	$V_{CC}$ = 480 V, I <sub>C</sub> = 12 A R <sub>G</sub> = 10 $\Omega$ V <sub>GE</sub> = 15 V, <i>Figure 19</i>	-	135 815 995	-	μJ μJ μJ
E <sub>on</sub> E <sub>off</sub> <sup>(1)</sup> E <sub>ts</sub>	Turn-on switching losses Turn-off switching losses Total switching losses	$V_{CC} = 480 \text{ V}, I_{C} = 12 \text{ A}$ $R_{G} = 10 \Omega, V_{GE} = 15 \text{ V},$ $T_{j} = 125 \text{ °C}$ <i>Figure 19</i>	-	200 1175 1375	-	μJ μJ μJ

1. Turn-off losses include also the tail of the collector current

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>F</sub>	Forward on-voltage	I <sub>F</sub> = 12 A I <sub>F</sub> = 12 A, T <sub>j</sub> = 125 °C		2.3 2.0		V V
t <sub>rr</sub> Q <sub>rr</sub> I <sub>rrm</sub>	Reverse recovery time Reverse recovery charge Reverse recovery current	I <sub>F</sub> = 12 A, V <sub>R</sub> =40 V, di/dt=100 A/μs <i>Figure 22</i>		31 29.5 1.9		ns nC A
t <sub>rr</sub> Q <sub>rr</sub> I <sub>rrm</sub>	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_F = 12 \text{ A}, V_R = 40 \text{ V},$ di/dt=100 A/µs, T <sub>j</sub> = 125 °C <i>Figure 22</i>		48.5 70.5 3		ns nC A

Table 8. Collector-emitter diode



### 2.1 Electrical characteristics (curves)

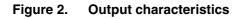
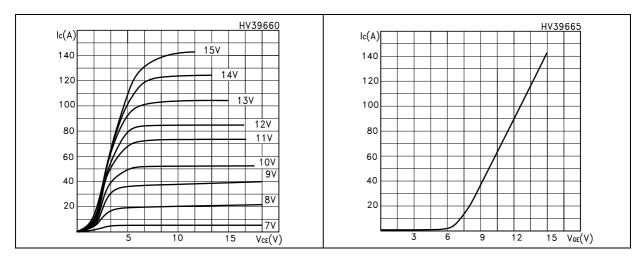
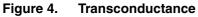
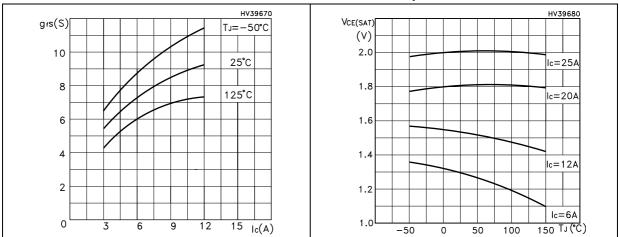


Figure 3. Transfer characteristics

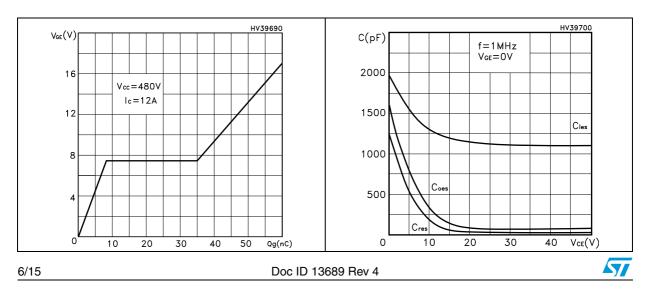




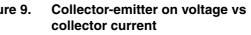








# Figure 8. Normalized gate threshold voltage Figure 9. vs temperature



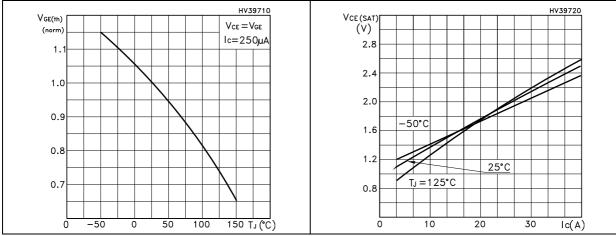


Figure 10. Normalized breakdown voltage vs Figure 11. Switching losses vs temperature temperature

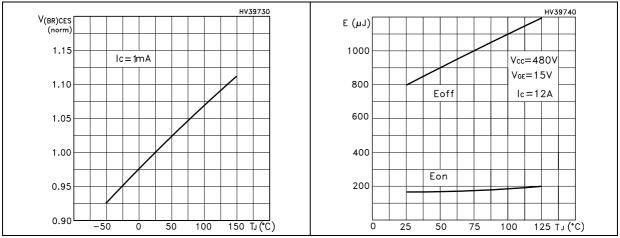
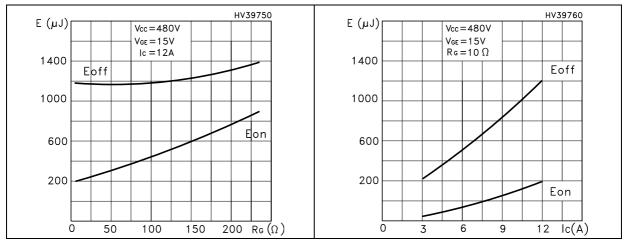


Figure 12. Switching losses vs gate resistance Figure 13. Switching losses vs collector current





 $Z_{th} = k R_{thJ-c}$ 

 $\delta = t_p / \tau$ 

0.02

0.01

+++

SINGLE PULSE

10-4

GC18400

 $10^{-1} t_{p}(s)$ 

### Figure 14. Turn-off SOA



Κ

 $10^{-1}$ 

10<sup>-2</sup>

10<sup>-5</sup>

 $\delta = 0.5$ 

0.2

0.1

0.05

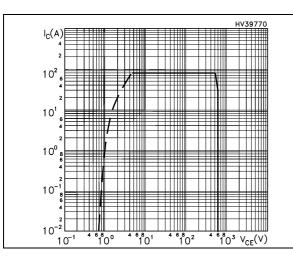


Figure 16. Thermal impedance for TO-220FP

Figure 17. Forward voltage drop versus forward current

10-3

10<sup>-2</sup>

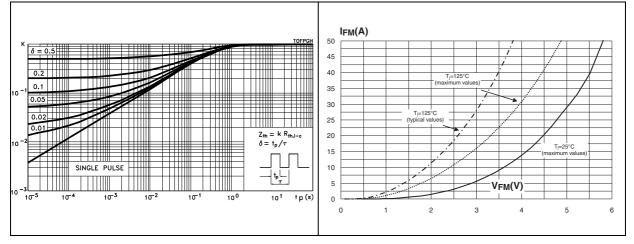
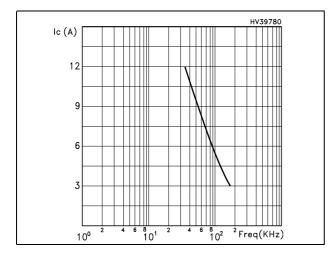


Figure 18. I<sub>C</sub> vs. frequency





### 2.2 Frequency applications

For a fast IGBT suitable for high frequency applications, the typical collector current vs. maximum operating frequency curve is reported. That frequency is defined as follows:

 $f_{MAX} = (P_D - P_C) / (E_{ON} + E_{OFF})$ 

• The maximum power dissipation is limited by maximum junction to case thermal resistance:

#### Equation 1

 $P_D = \Delta T / R_{THJ-C}$ 

considering  $\Delta T = T_J - T_C = 125 \text{ °C} - 75 \text{ °C} = 50 \text{ °C}$ 

• The conduction losses are:

### **Equation 2**

 $P_C = I_C * V_{CE(SAT)} * \delta$ 

with 50% of duty cycle, V<sub>CESAT</sub> typical value @125°C.

• Power dissipation during ON & OFF commutations is due to the switching frequency:

#### Equation 3

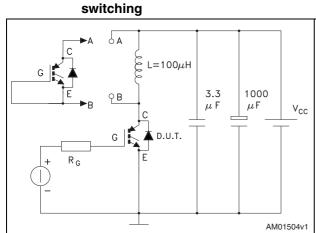
 $P_{SW} = (E_{ON} + E_{OFF}) * freq.$ 

Typical values @ 125°C for switching losses are used (test conditions:  $V_{CE} = 480V$ ,  $V_{GE}=15V$ ,  $R_G = 10$  Ohm). Furthermore, diode recovery energy is included in the  $E_{ON}$  (see *Note 1*), while the tail of the collector current is included in the  $E_{OFF}$  measurements.



## 3 Test circuits

Figure 19. Test circuit for inductive load



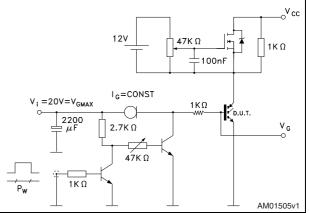
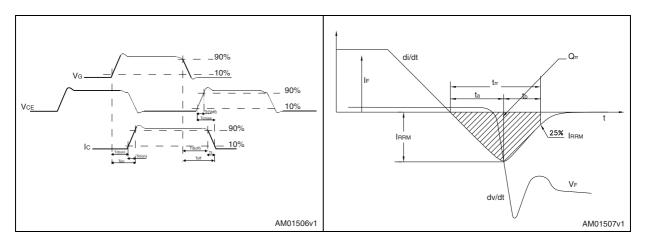


Figure 20. Gate charge test circuit

Figure 21. Switching waveform







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### 4 Package mechanical data

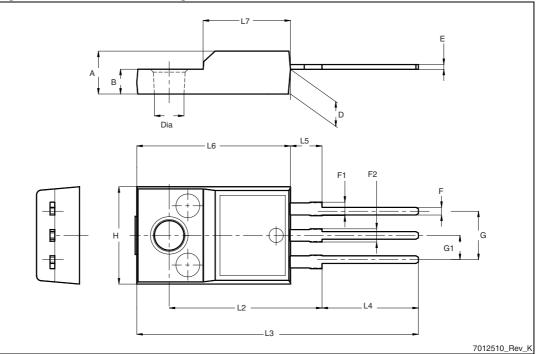
In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.



Dim		mm					
Dim.	Min.	Тур.	Max.				
А	4.4		4.6				
В	2.5		2.7				
D	2.5		2.75				
E	0.45		0.7				
F	0.75		1				
F1	1.15		1.70				
F2	1.15		1.70				
G	4.95		5.2				
G1	2.4		2.7				
Н	10		10.4				
L2		16					
L3	28.6		30.6				
L4	9.8		10.6				
L5	2.9		3.6				
L6	15.9		16.4				
L7	9		9.3				
Dia	3		3.2				

Table 9. TO-220FP mechanical data

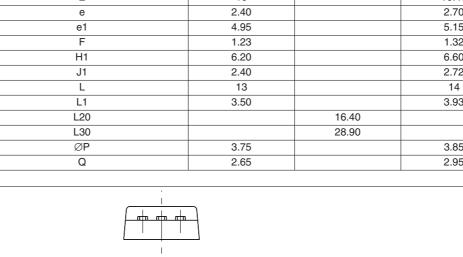
### Figure 23. TO-220FP drawing

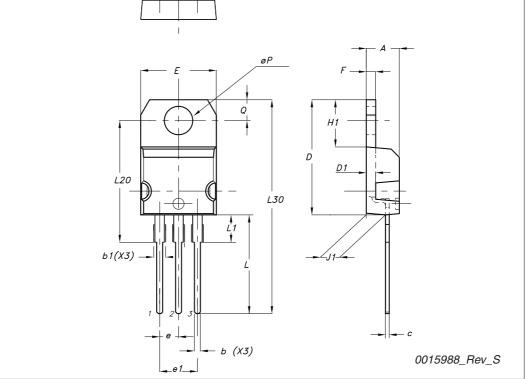




Dim	mm		
	Min	Тур	Max
Α	4.40		4.60
b	0.61		0.88
b1	1.14		1.70
С	0.48		0.70
D	15.25		15.75
D1		1.27	
E	10		10.40
е	2.40		2.70
e1	4.95		5.15
F	1.23		1.32
H1	6.20		6.60
J1	2.40		2.72
L	13		14
L1	3.50		3.93
L20		16.40	
L30		28.90	
ØP	3.75		3.85
Q	2.65		2.95

TO-220 type A mechanical data





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Doc ID 13689 Rev 4

## 5 Revision history

Date	Revision	Changes	
02-Jul-2007	1	First release	
13-Aug-2007	2	From target to preliminary version	
18-Sep-2007	3	Added new section: <i>Electrical characteristics (curves)</i>	
05-Nov-2010	4	<ul> <li>Cover page has been updated</li> <li>Modified gate threshold voltage range on <i>Table 4: Static</i></li> <li>Updated TO-220 mechanical data</li> <li>Added new package, mechanical data: TO-220FP</li> </ul>	



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